

Nanocomposites and nanomaterials

Simulation of X-ray Diffraction Profiles for Compositionally Graded $\text{Al}_x\text{Ga}_{1-x}\text{N}$ Layers and Nanowires

**H.V. Stanchu¹, A.V. Kuchuk^{1,2}, V.P. Kladko¹, M.E. Ware², Yu.I. Mazur²,
Z.R. Zytkeiwicz³, G.J. Salamo²**

¹ *V. Lashkaryov Institute of Semiconductor Physics, National Academy of Sciences of Ukraine, Pr. Nauky 45, Kyiv 03028, Ukraine. E-mail: sh@isp.kiev.ua*

² *Institute for Nanoscience & Engineering, University of Arkansas, W. Dickson 731, Fayetteville, Arkansas 72701, USA.*

³ *Institute of Physics, Polish Academy of Sciences, Al. Lotnikow 32/46, 02-668 Warsaw, Poland*

The demonstration of *p*-type doping through the so-called polarization doping technique for graded $\text{Al}_x\text{Ga}_{1-x}\text{N}$ alloys is finding more practical applications in modern optoelectronic devices. The Al depth profile is the key factor in modifying the properties of $\text{Al}_x\text{Ga}_{1-x}\text{N}$ graded layers (GLs) and nanowires (NWs). The different in- and out-of-plane strain profiles resulting from the free surface of NWs leads to the difference in: (i) the polarization-induced doping carrier densities and (ii) the strain-related defects density. Also, there is a difference between the strain profiles of catalyst-free and top-down fabricated NWs obtained by dry etching. Therefore, tuning the properties of $\text{Al}_x\text{Ga}_{1-x}\text{N}$ GLs and NWs requires a rapid and reliable characterization of the chemical composition and strain depth profiles.

High resolution X-ray diffraction (HRXRD) is a nondestructive technique that permits rapid determination of the chemical composition, strain state, and thickness of epitaxial GLs. In this study we extend the HRXRD method to the case of graded $\text{Al}_x\text{Ga}_{1-x}\text{N}$ NWs produced either by catalyst-free MBE growth or by dry etching of planar structures. The symmetrical $2\theta/\omega$ - scans for GLs and NWs are calculated through the kinematical theory of X-ray diffraction. The influence of $\text{Al}_x\text{Ga}_{1-x}\text{N}$ thickness, Al(%), and deformation distribution on the shape of the intensity profile is studied theoretically. Particular attention is paid to the in-plane lattice parameter relaxation in $\text{Al}_x\text{Ga}_{1-x}\text{N}$ NWs due to the free sidewalls and how this compares with continuous coherently grown $\text{Al}_x\text{Ga}_{1-x}\text{N}$ GLs. In addition, as opposed to homogeneous dry etched structures, NW inhomogeneity must be considered for catalyst-free grown NWs. Thus, we calculated the XRD profiles for a whole $\text{Al}_x\text{Ga}_{1-x}\text{N}$ NWs ensemble taking into account the diameter distribution resulting in a distribution of the in-plane relaxation for a given depth.

